

US0D1073632S

(12) **United States Design Patent** (10) **Patent No.:** **US D1,073,632 S**
McPherson et al. (45) **Date of Patent:** **** May 6, 2025**

(54) **POWER MODULE**

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(73) Assignee: **WOLFSPEED, INC.**, Durham, NC (US)

(**) Term: **15 Years**

(21) Appl. No.: **29/780,368**

(22) Filed: **Apr. 23, 2021**

(51) **LOC (15) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**
USPC D13/182, 180

(Continued)

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Primary Examiner — Selina Sikder

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(57) **CLAIM**

The ornamental design for a power module, as shown and described.

DESCRIPTION

FIG. 1 is a front perspective view showing an embodiment of a power module;

FIG. 2 is a bottom perspective view of the power module of FIG. 1;

FIG. 3 is a top view of the power module of FIG. 1;

FIG. 4 is a bottom view of the power module of FIG. 1;

FIG. 5 is a side view of the power module of FIG. 1;

FIG. 6 is an opposing side view of the power module of FIG. 1;

FIG. 7 is an end view of the power module of FIG. 1;

FIG. 8 is an opposing end view of the power module of FIG. 1;

FIG. 9 is a front perspective view showing an embodiment of a power module;

FIG. 10 is a bottom perspective view of the power module of FIG. 9;

FIG. 11 is a top view of the power module of FIG. 9;

FIG. 12 is a bottom view of the power module of FIG. 9;

FIG. 13 is a side view of the power module of FIG. 9;

FIG. 14 is an opposing side view of the power module of FIG. 9;

FIG. 15 is an end view of the power module of FIG. 9;

FIG. 16 is an opposing end view of the power module of FIG. 9;

FIG. 17 is a front perspective view showing an embodiment of a power module;

FIG. 18 is a bottom perspective view of the power module of FIG. 17;

FIG. 19 is a top view of the power module of FIG. 17;

FIG. 20 is a bottom view of the power module of FIG. 17;

FIG. 21 is a side view of the power module of FIG. 17;

FIG. 22 is an opposing side view of the power module of FIG. 17;

FIG. 23 is an end view of the power module of FIG. 17; and,

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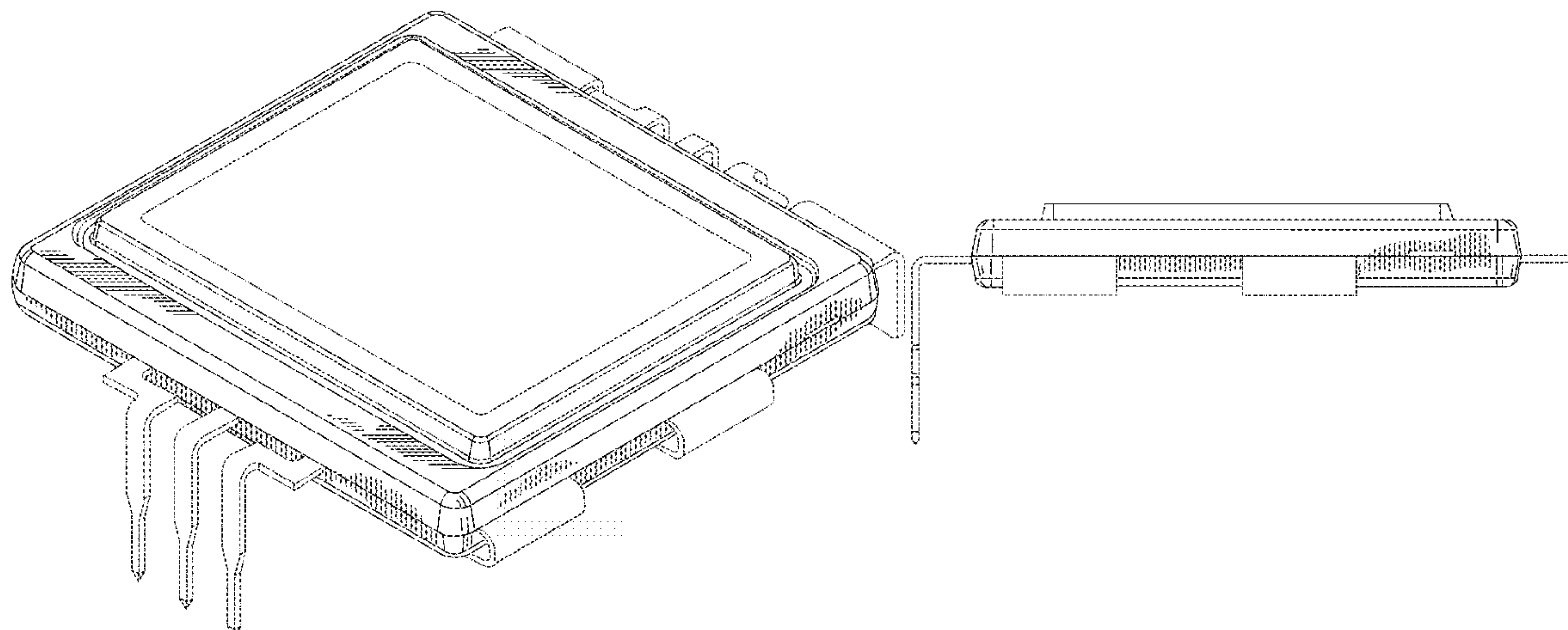


FIG. 24 is an opposing end view of the power module of FIG. 17.

The broken lines shown in the drawings depict portions of the power module that form no part of the claimed design.

1 Claim, 24 Drawing Sheets

(58) Field of Classification Search

CPC H01L 23/49575; H01L 23/49827; H01L 23/49811; H01L 24/97

See application file for complete search history.

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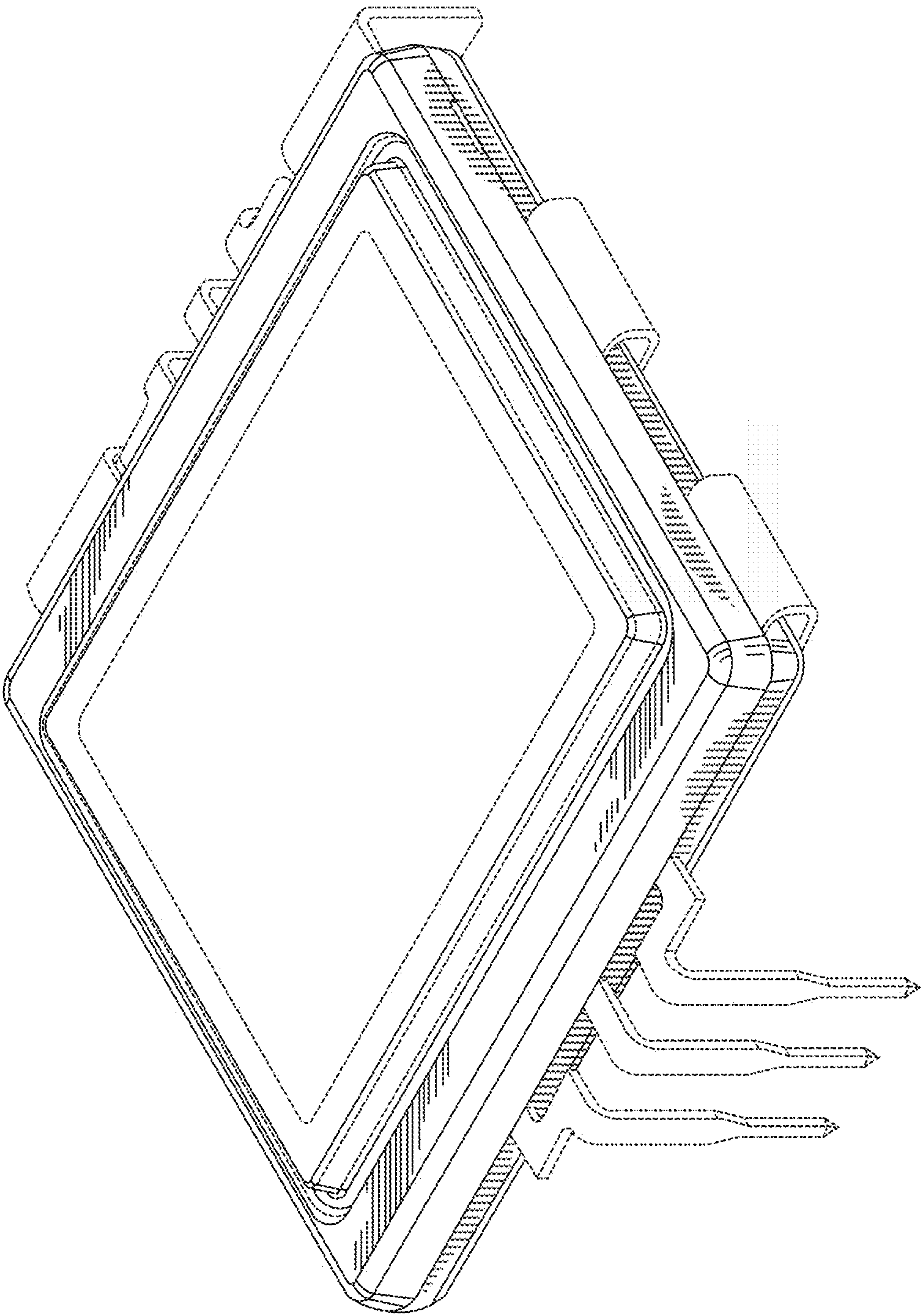


FIG. 1

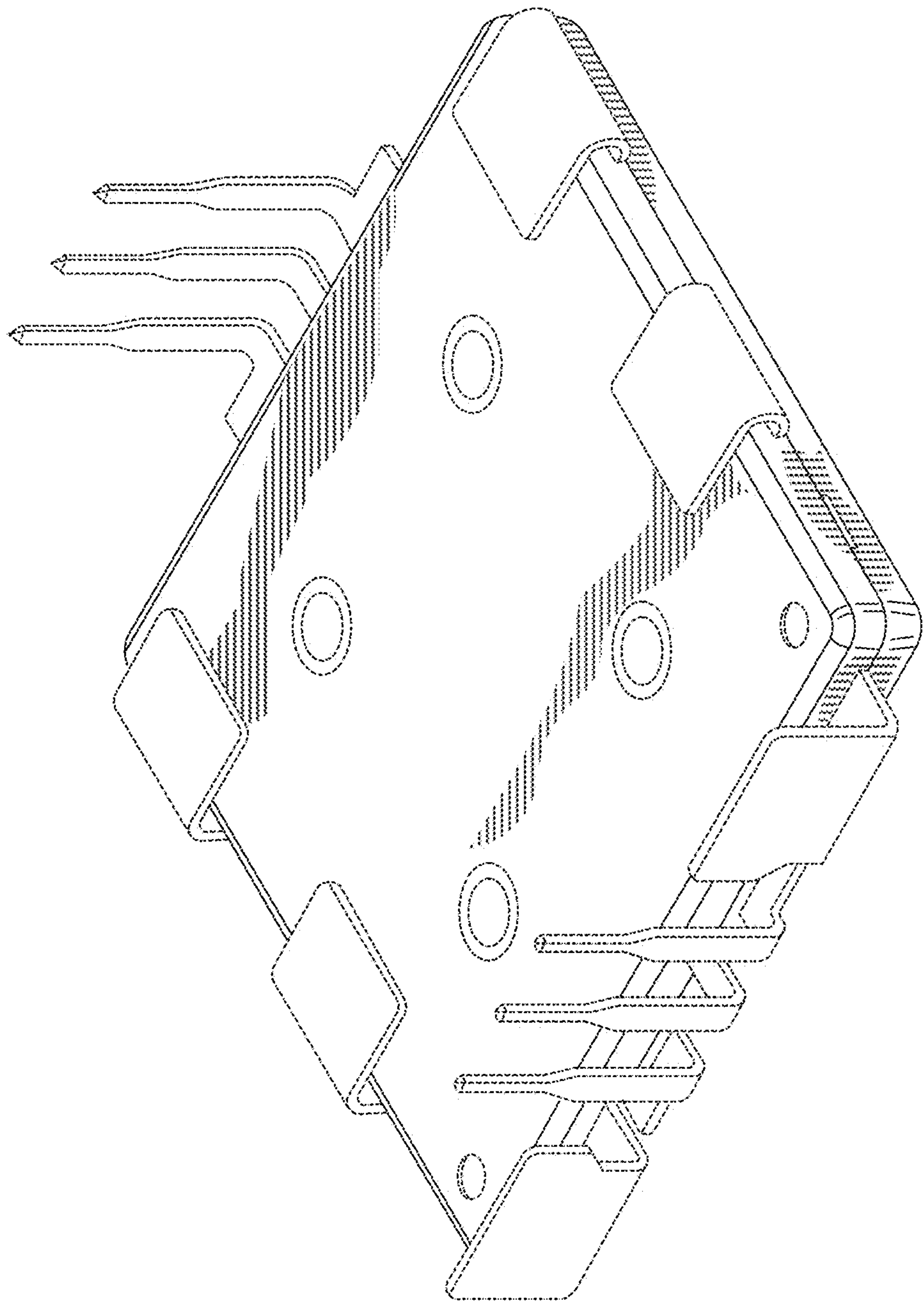


FIG. 2

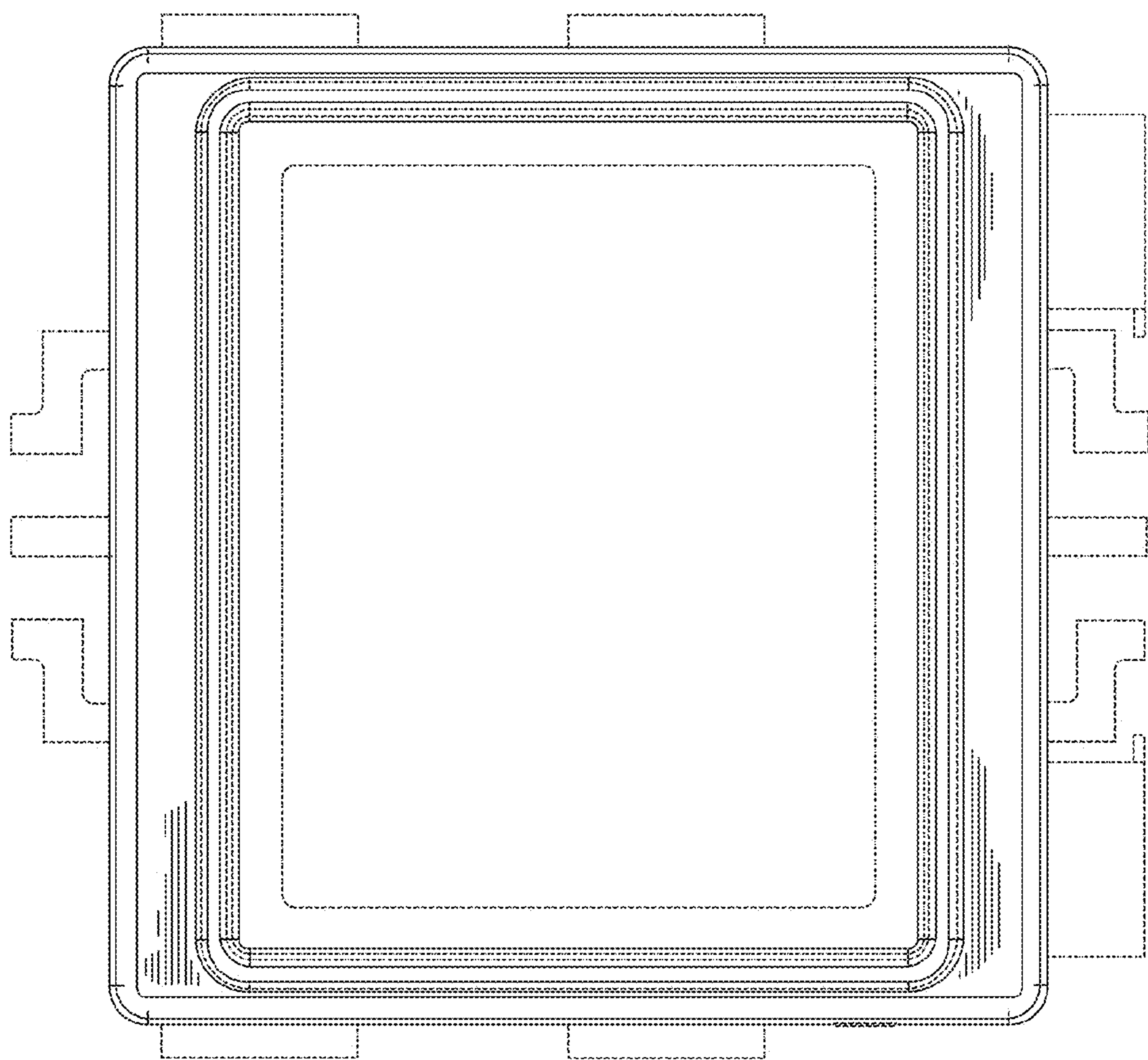


FIG. 3

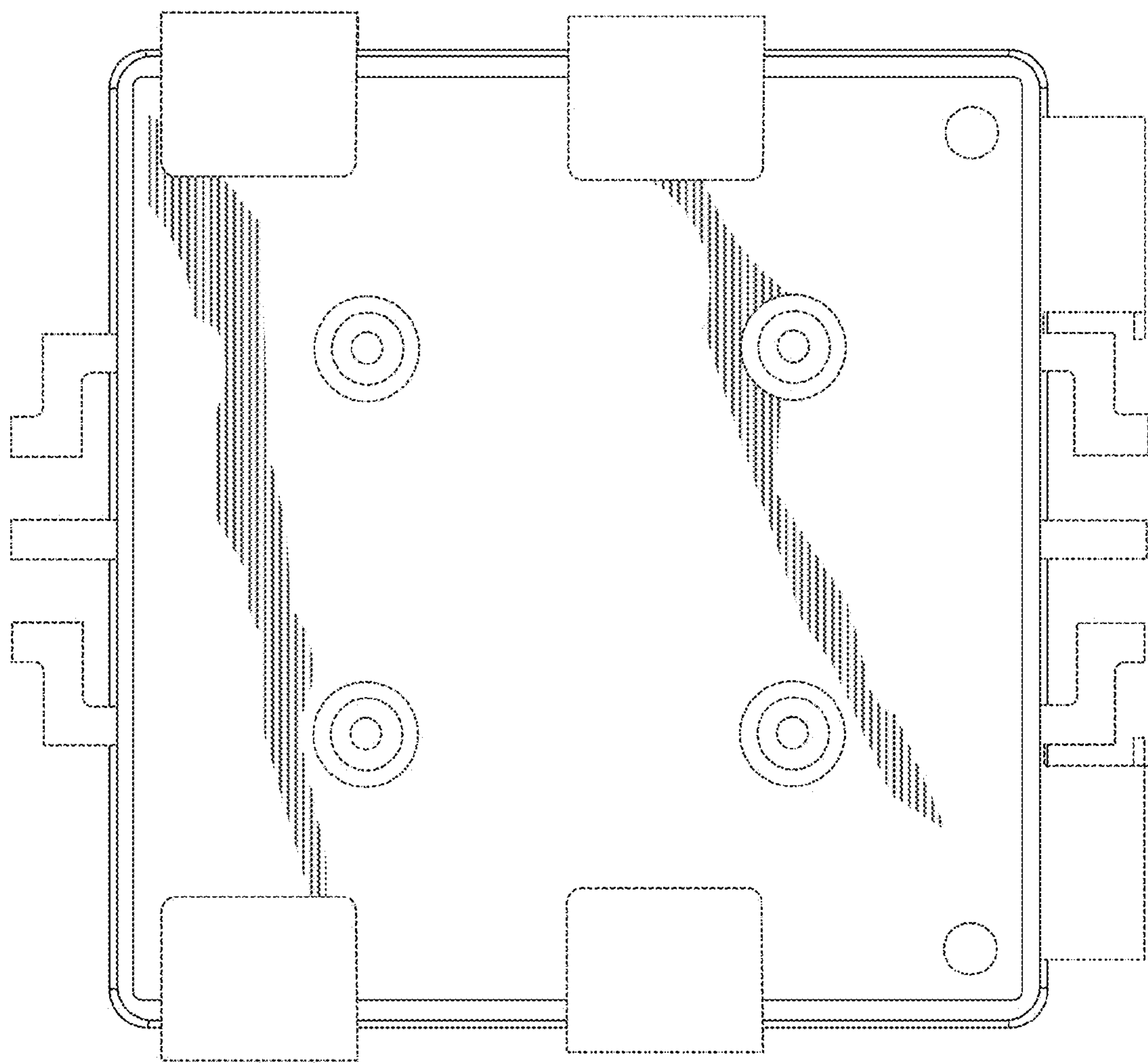


FIG. 4

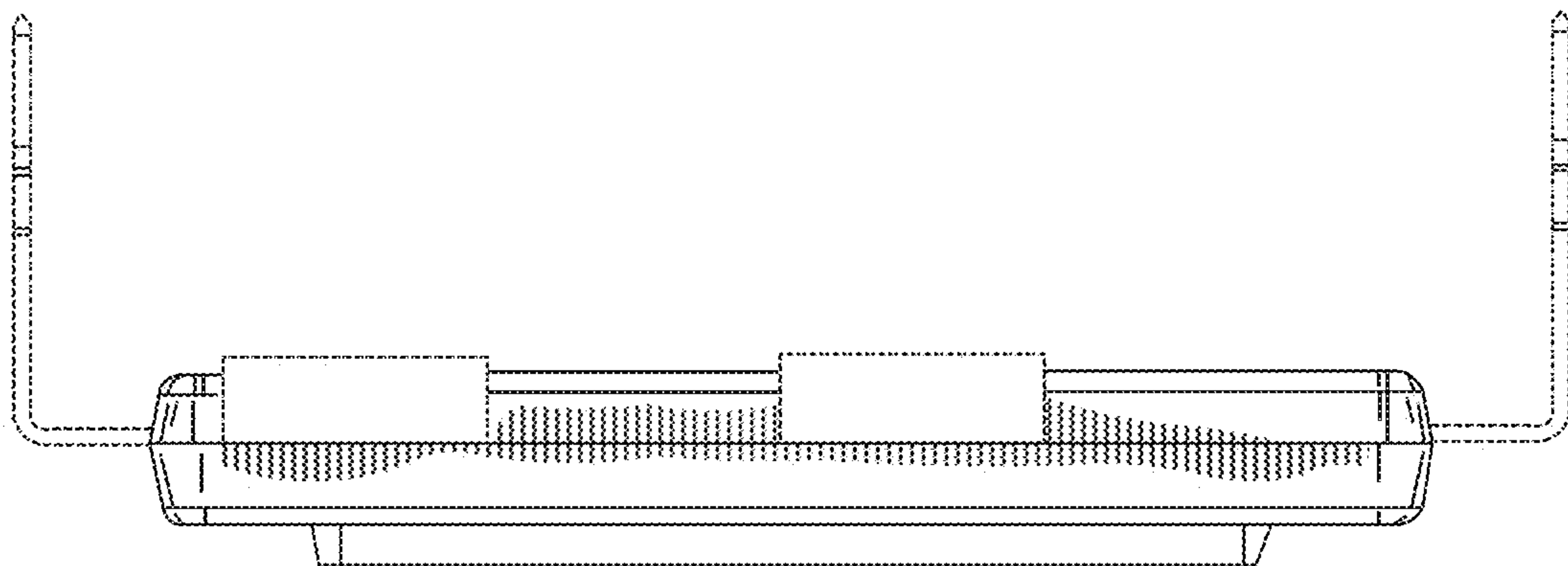


FIG. 5

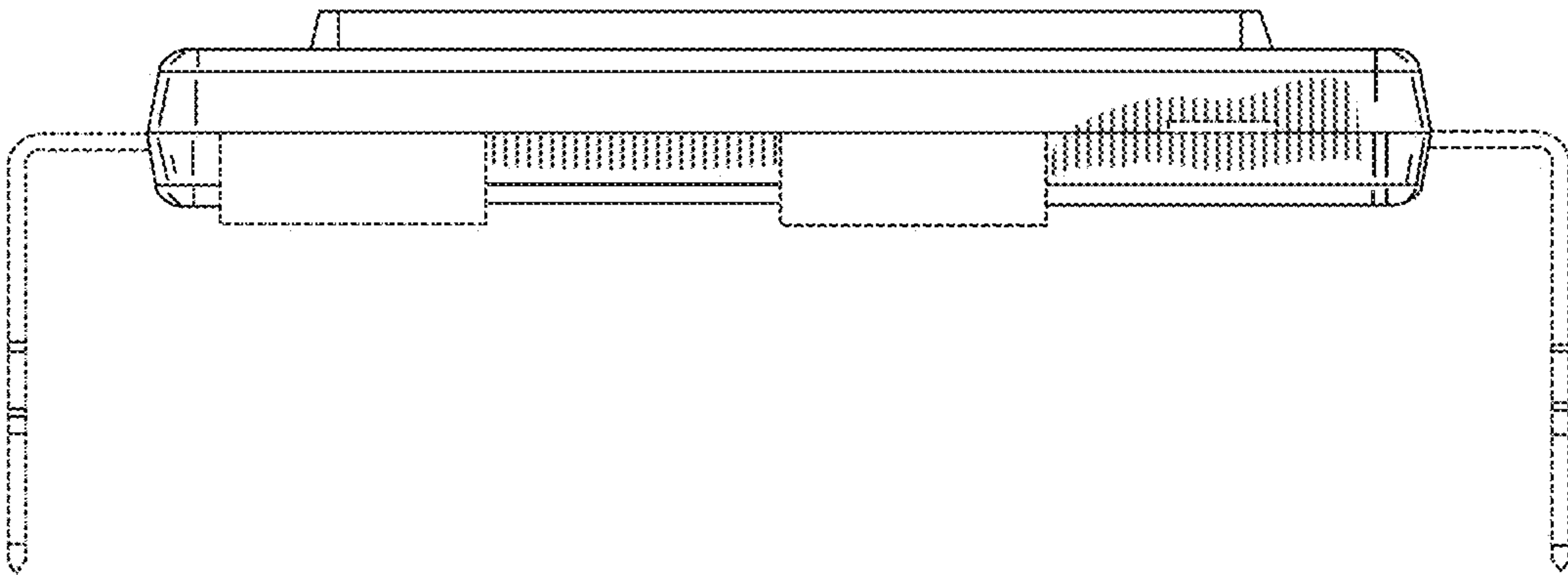


FIG. 6

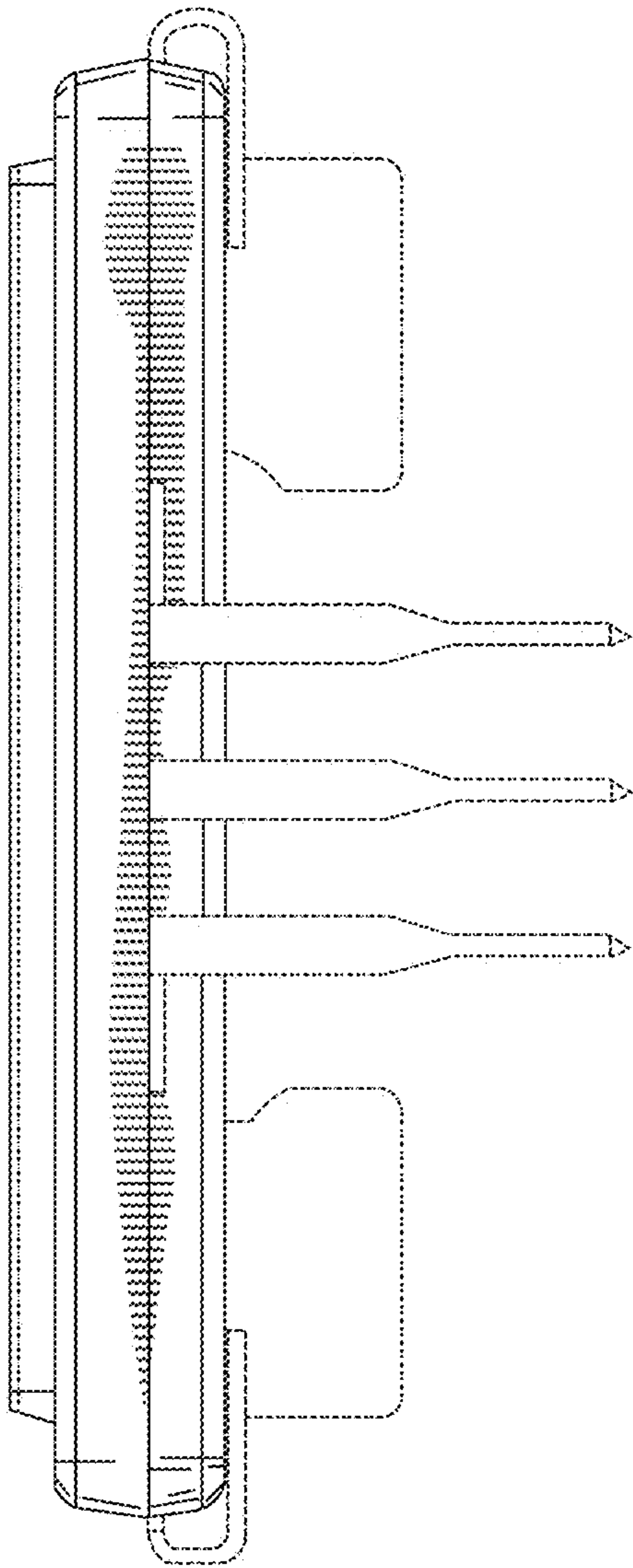


FIG. 7

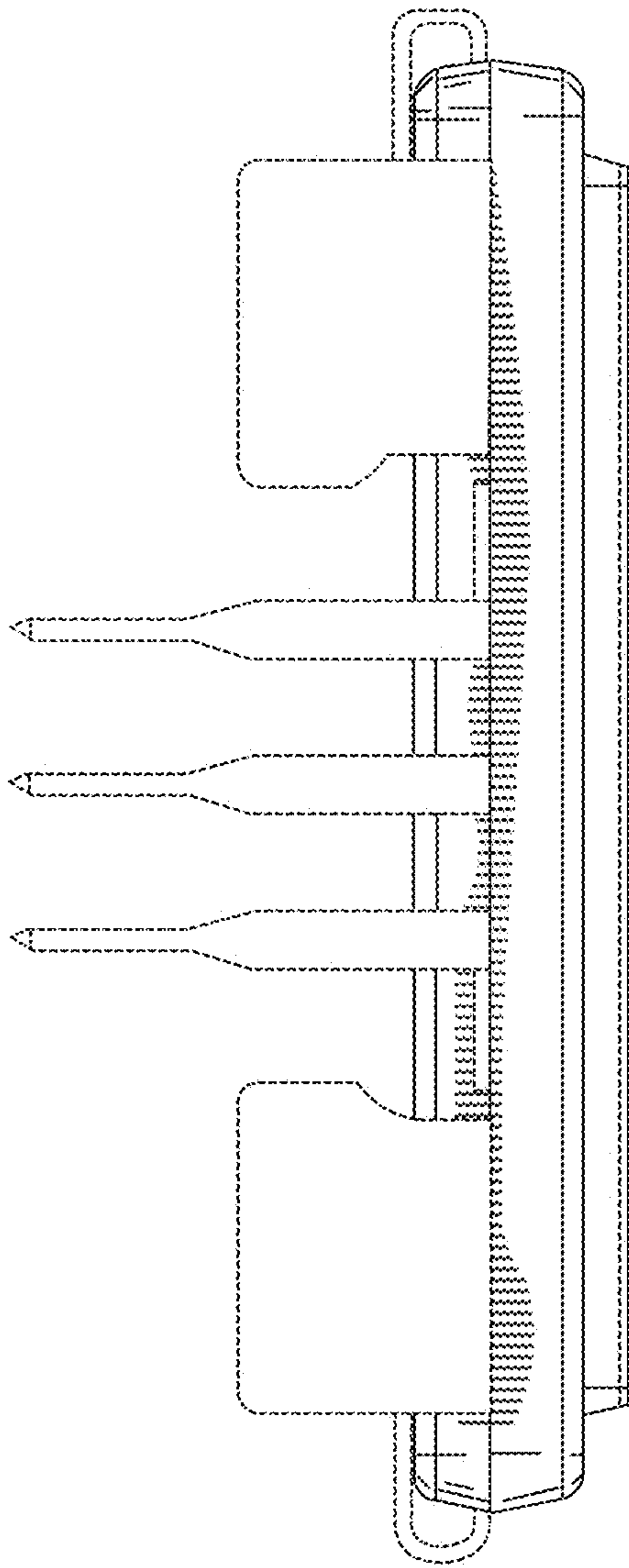


FIG. 8

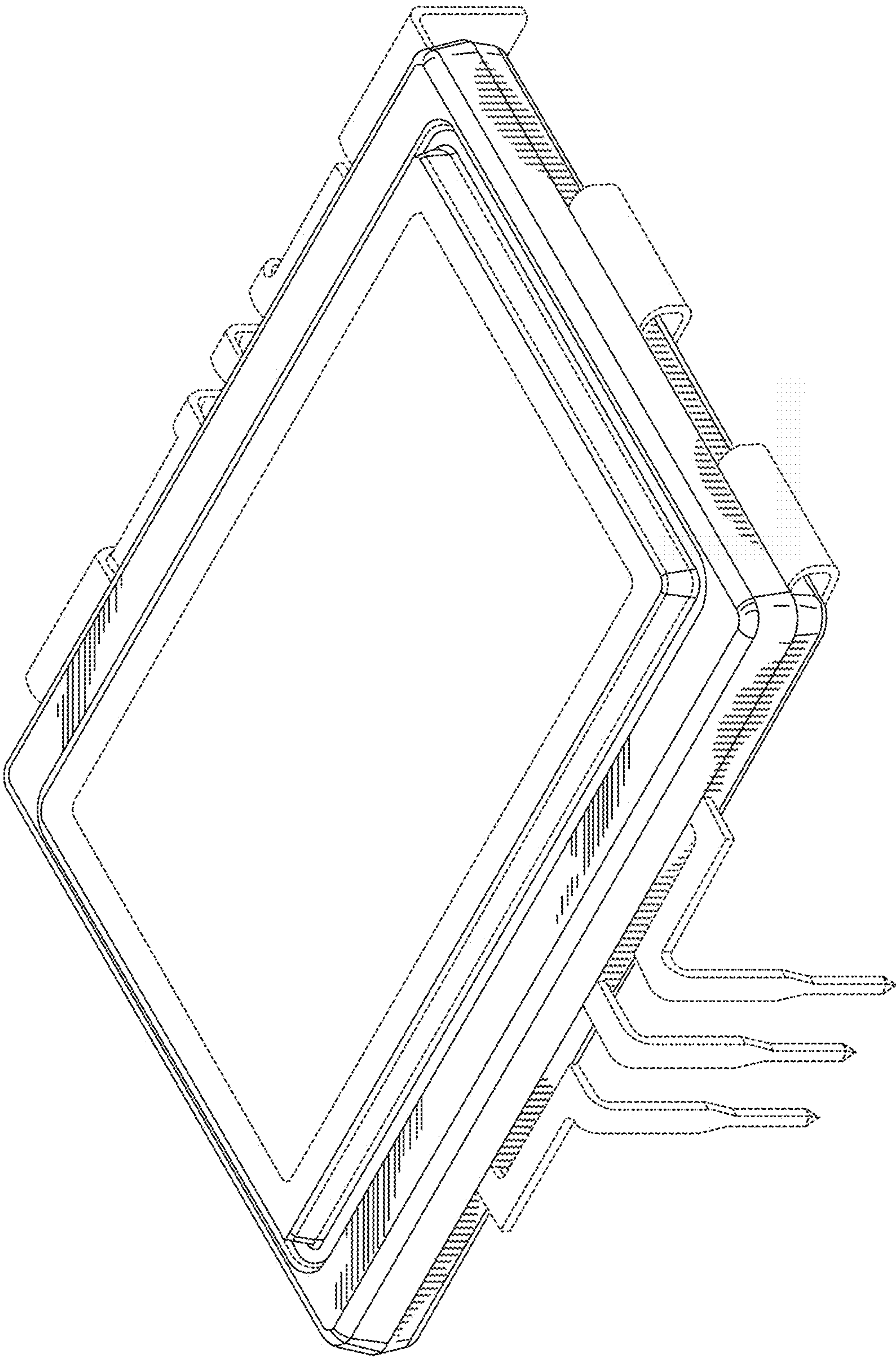


FIG. 9

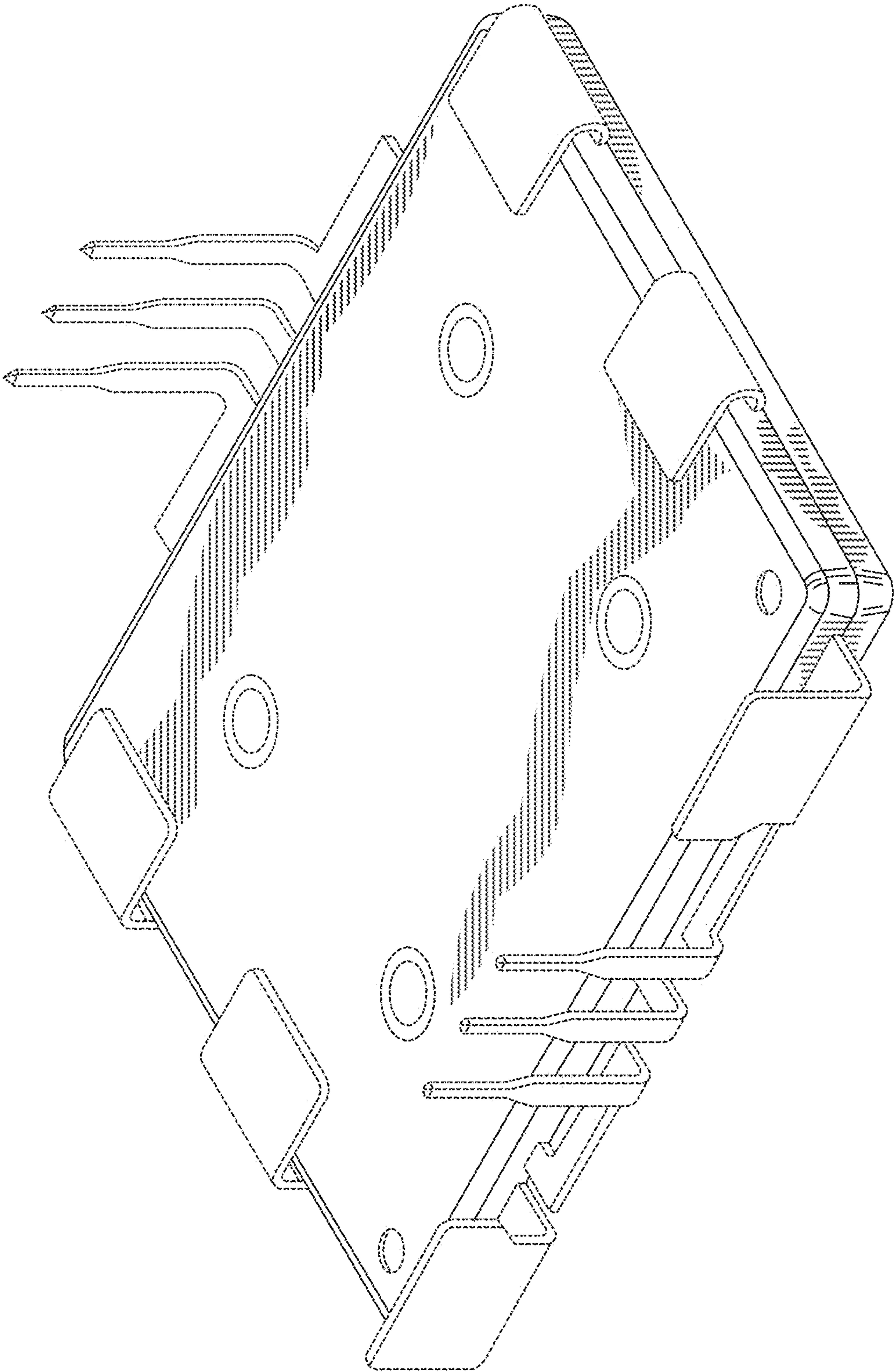


FIG. 10

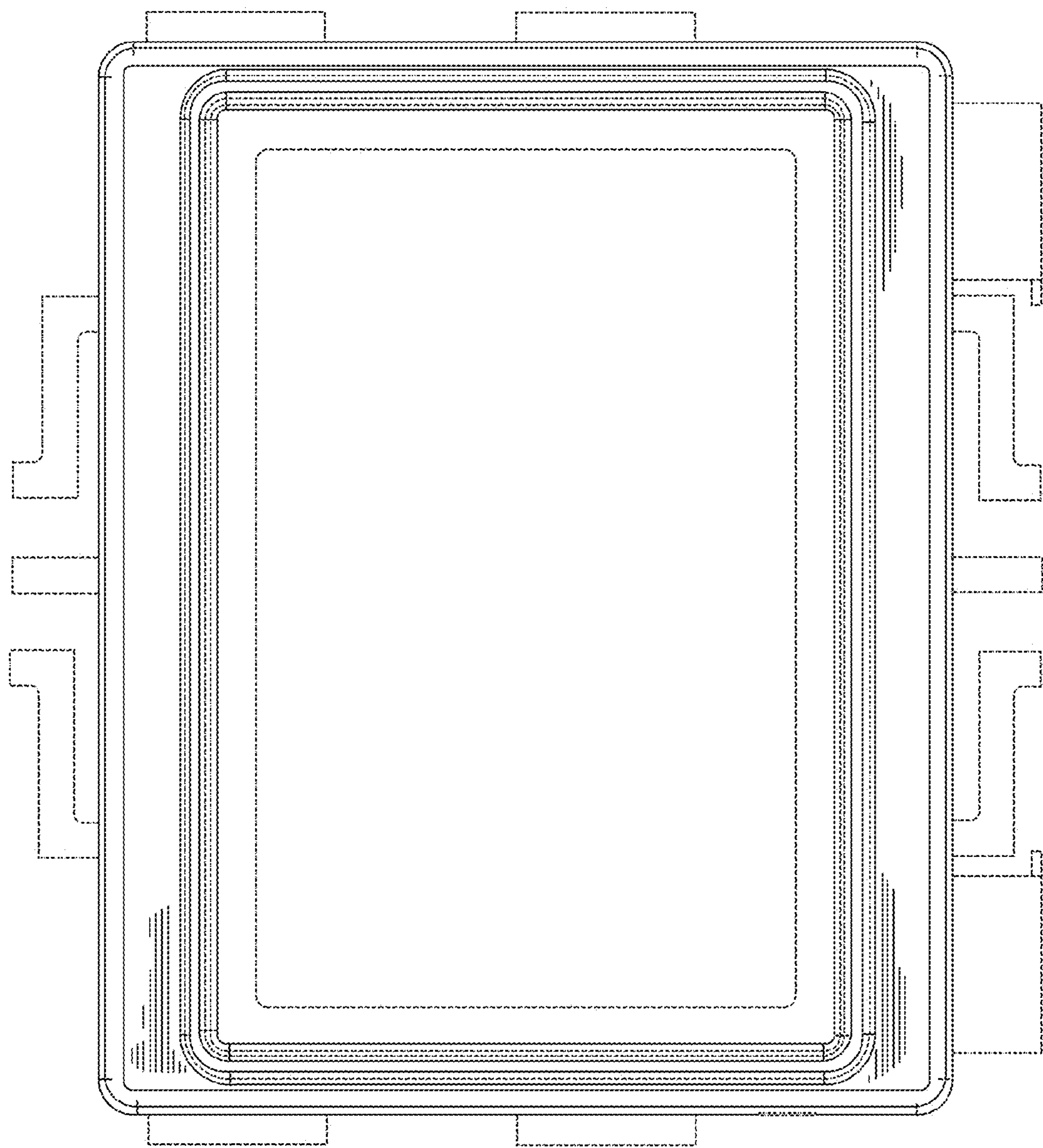


FIG. 11

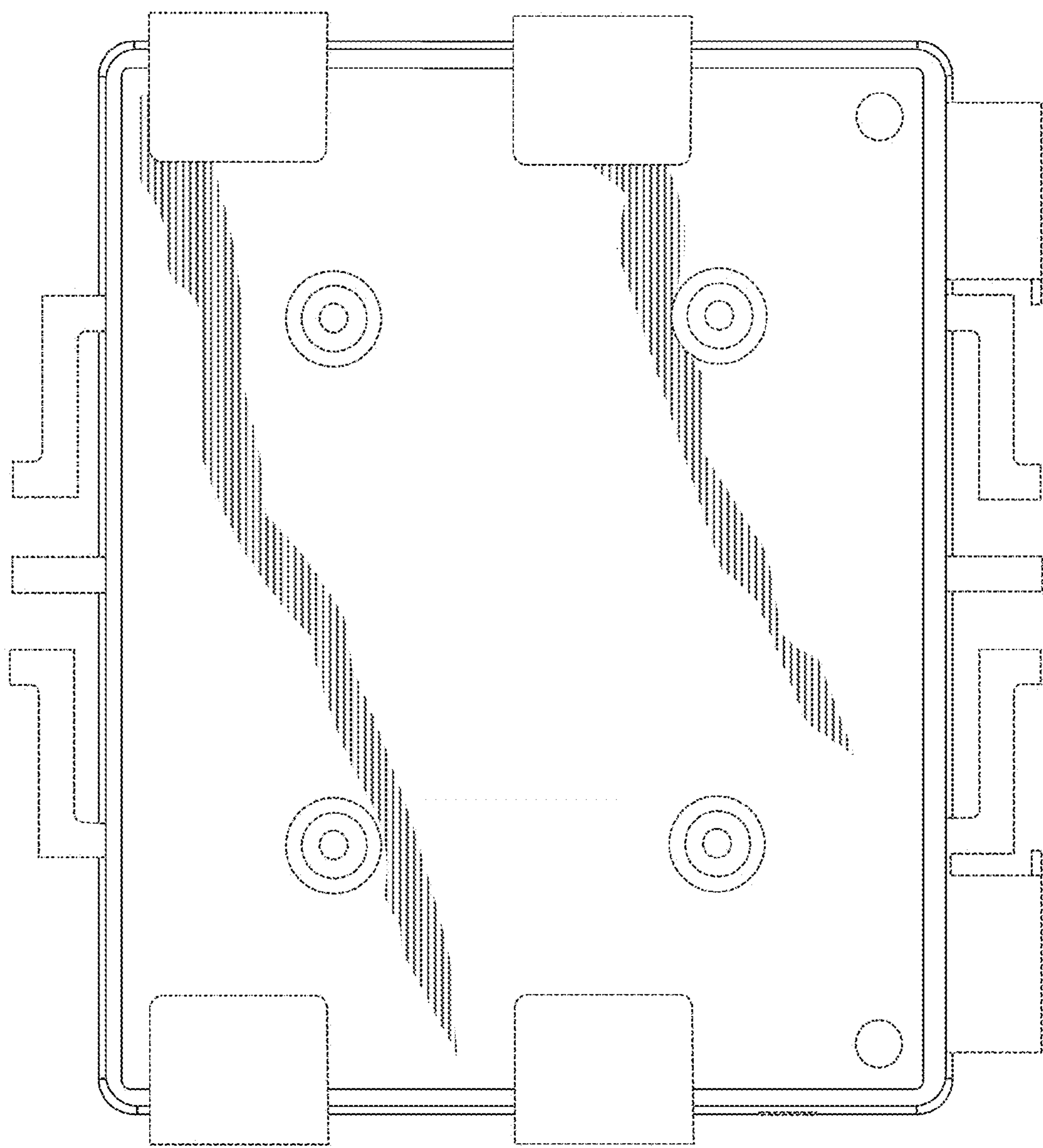


FIG. 12

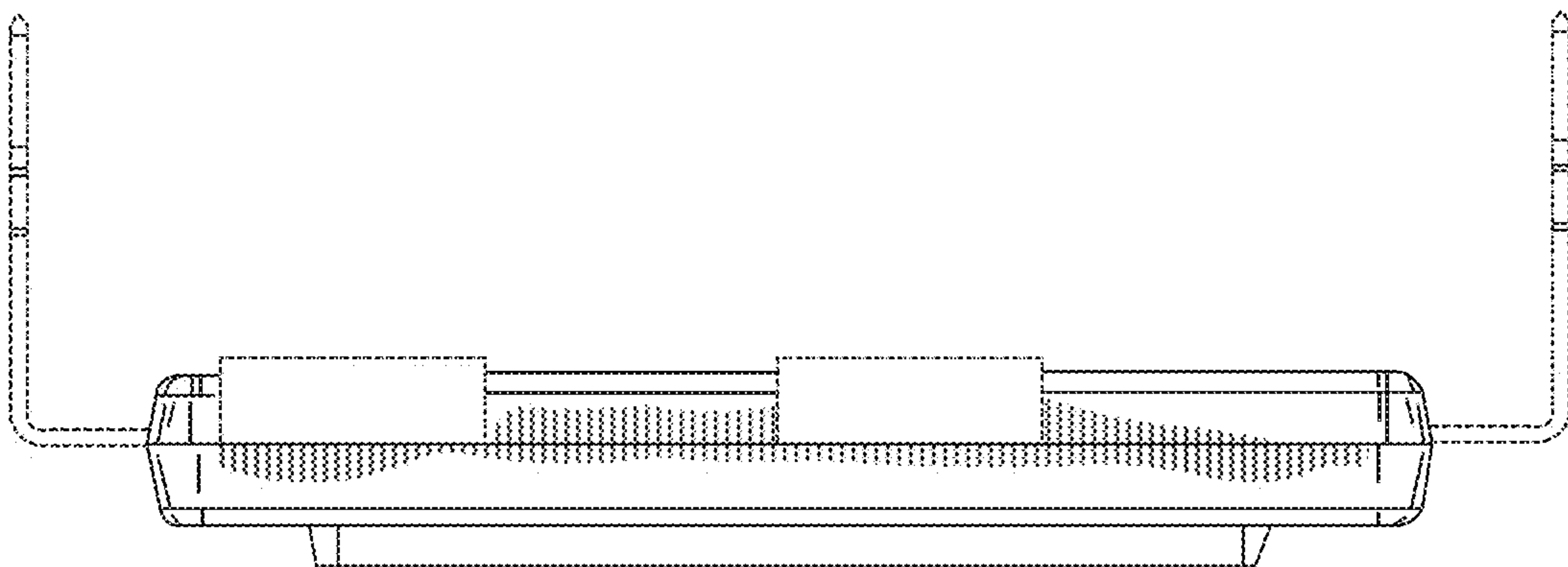


FIG. 13

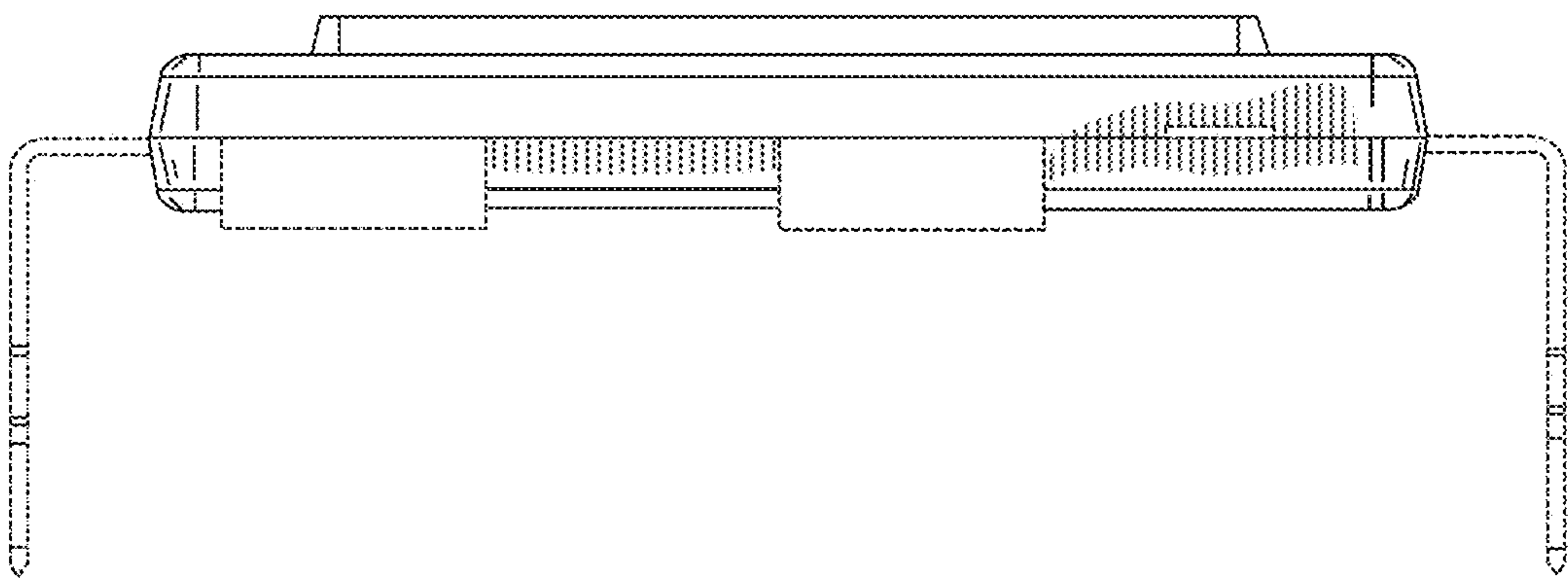


FIG. 14

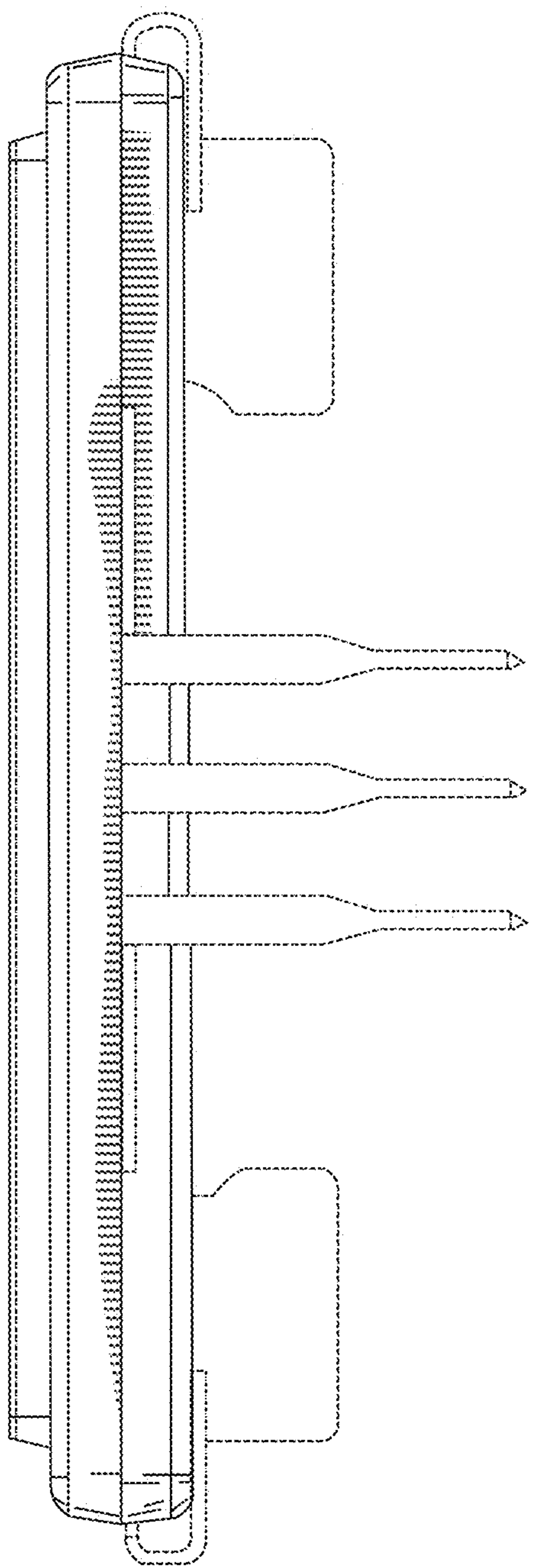


FIG. 15

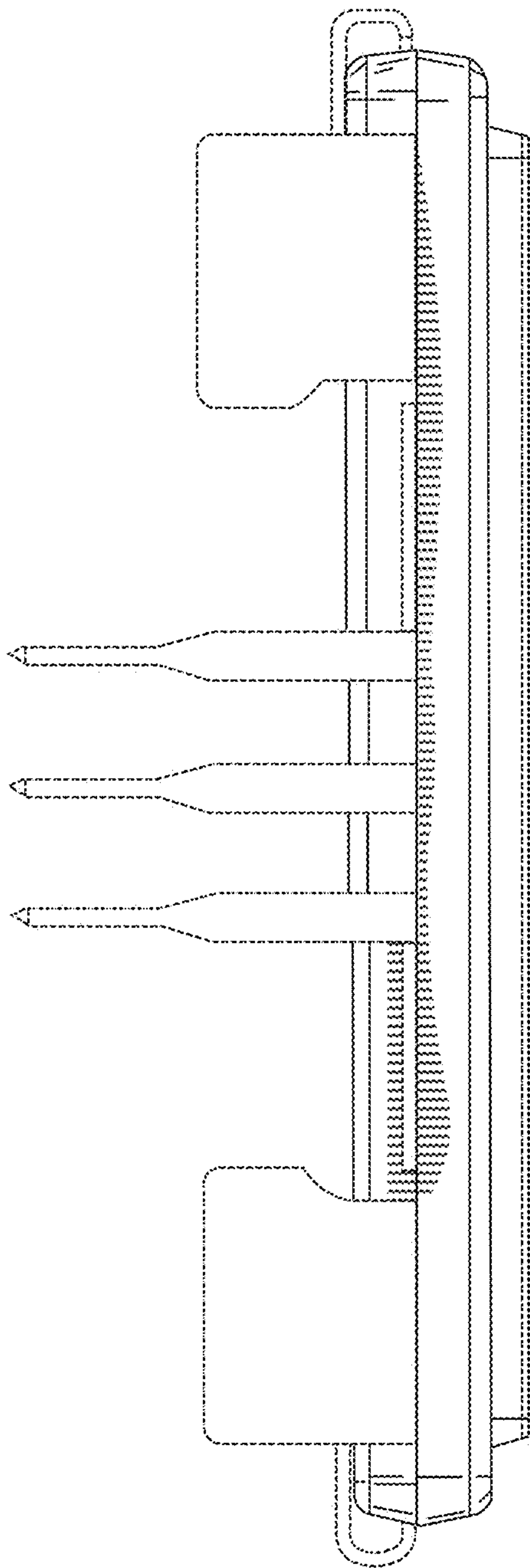


FIG. 16

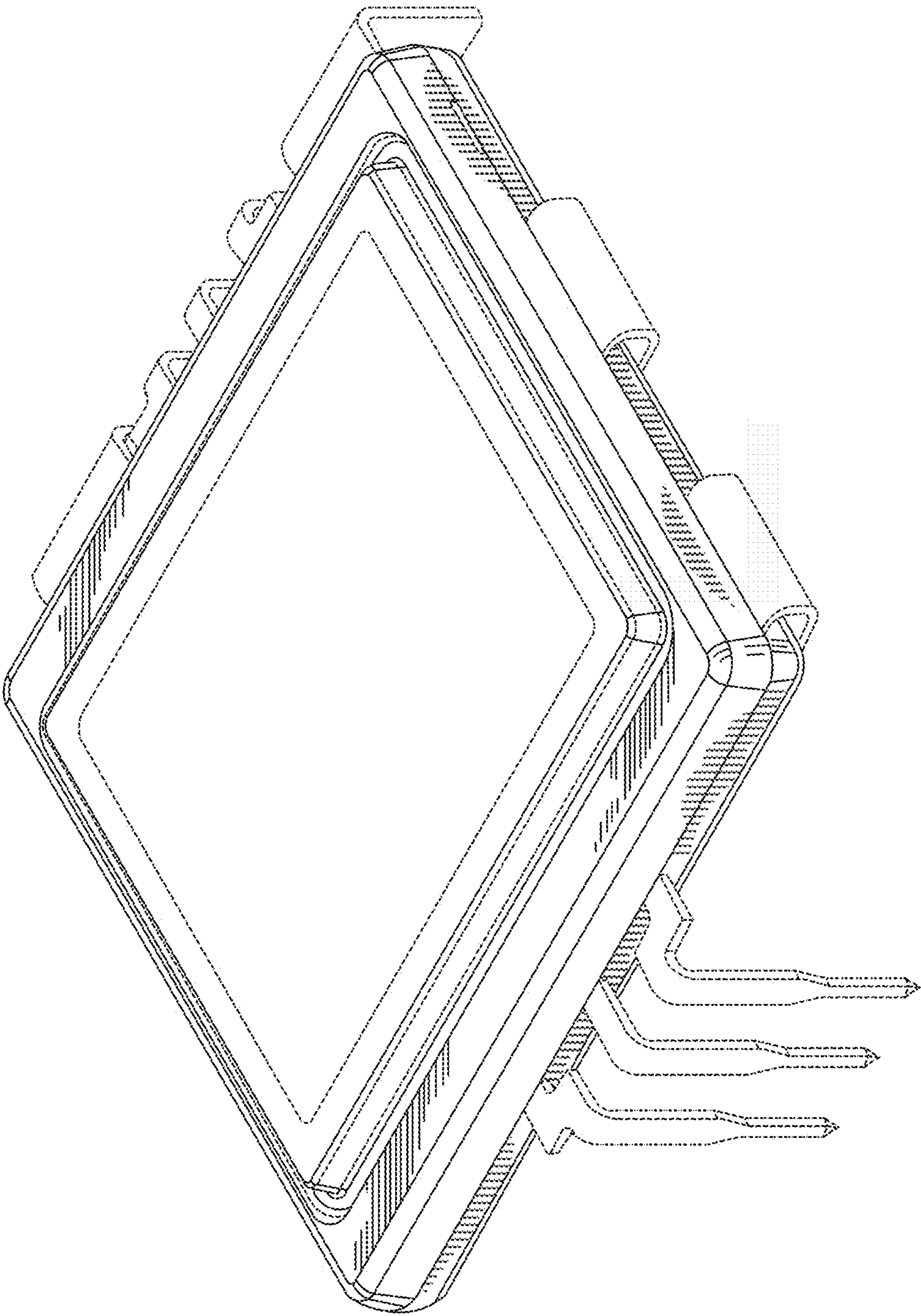


FIG. 17

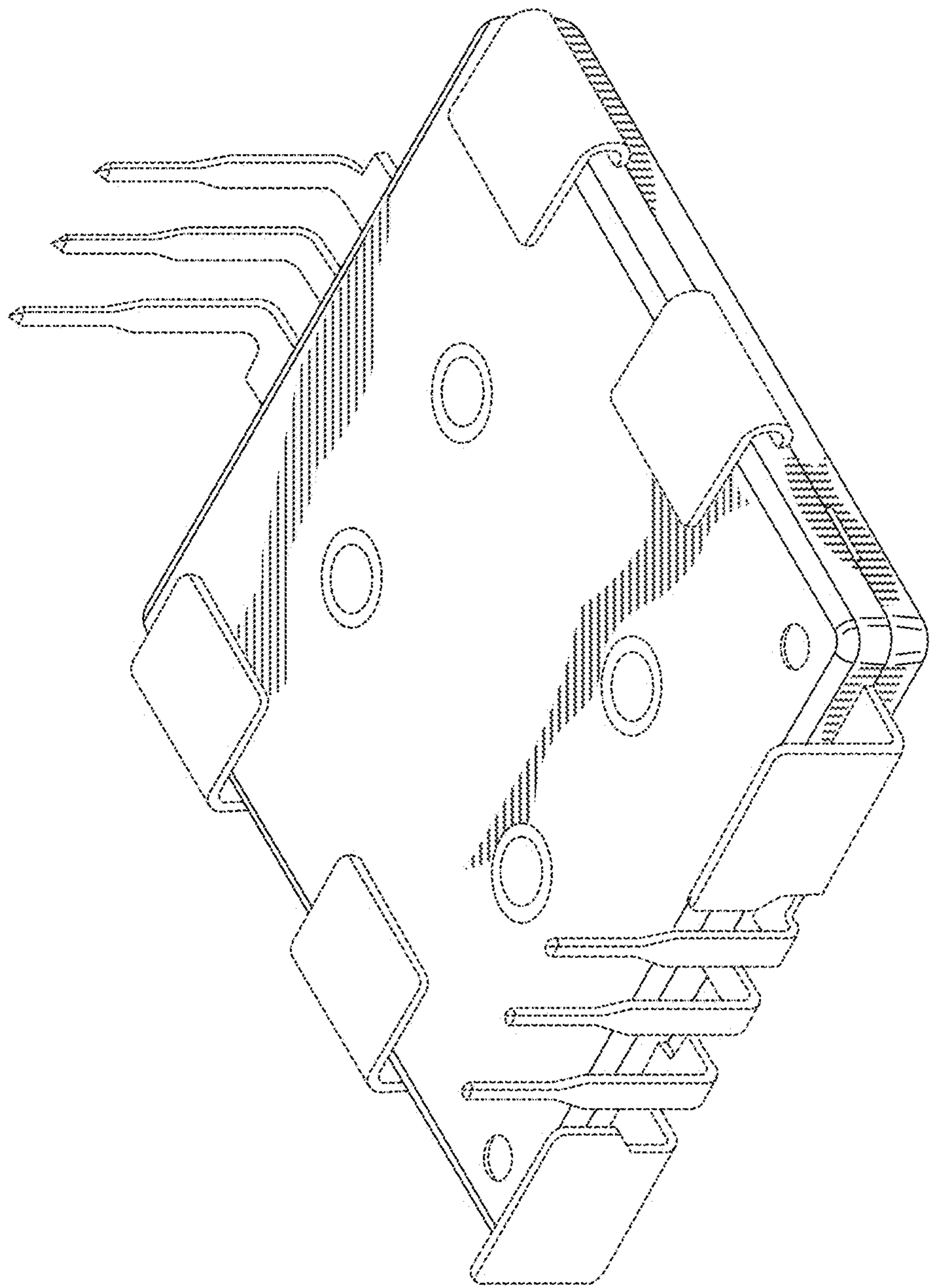


FIG. 18

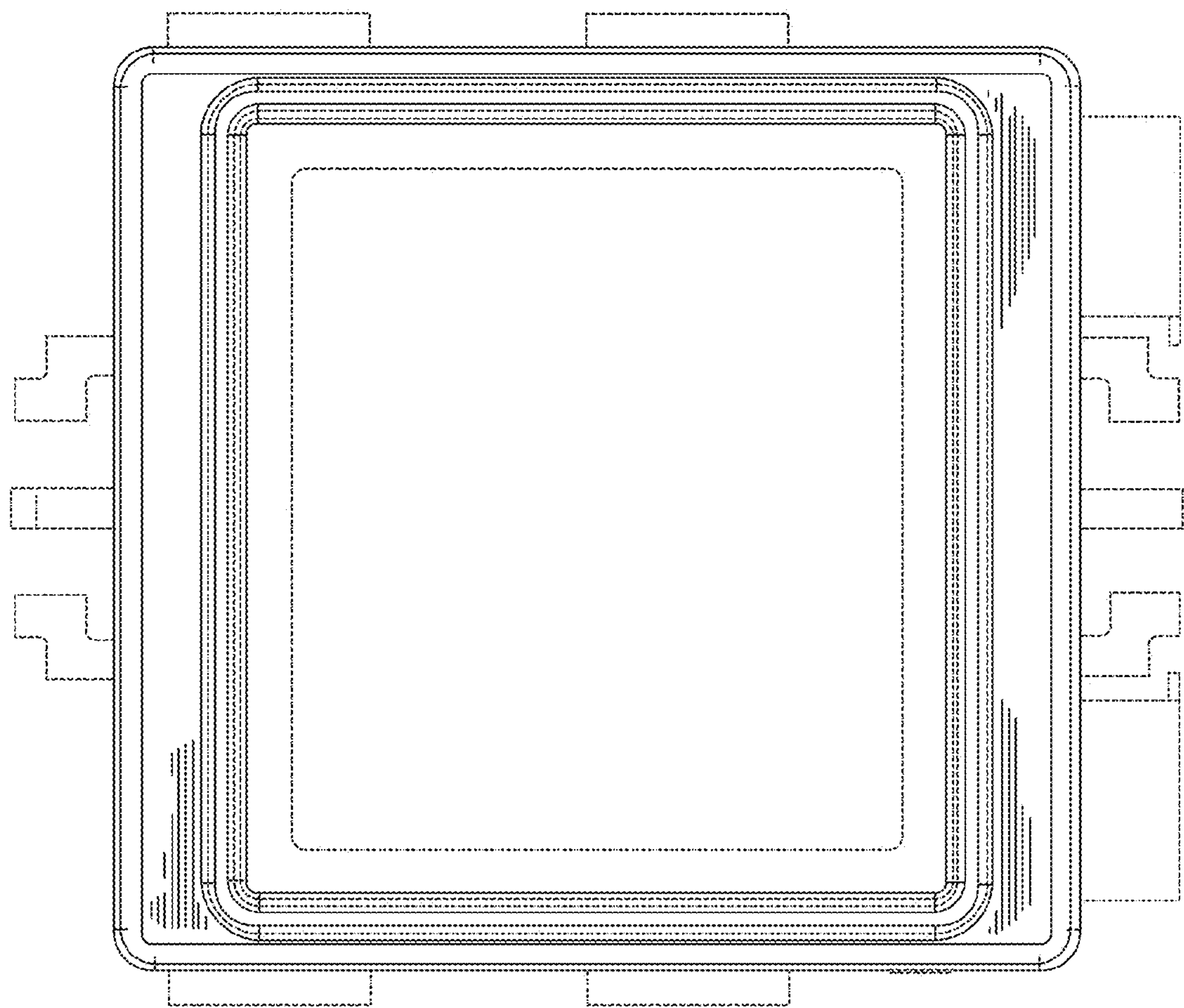


FIG. 19

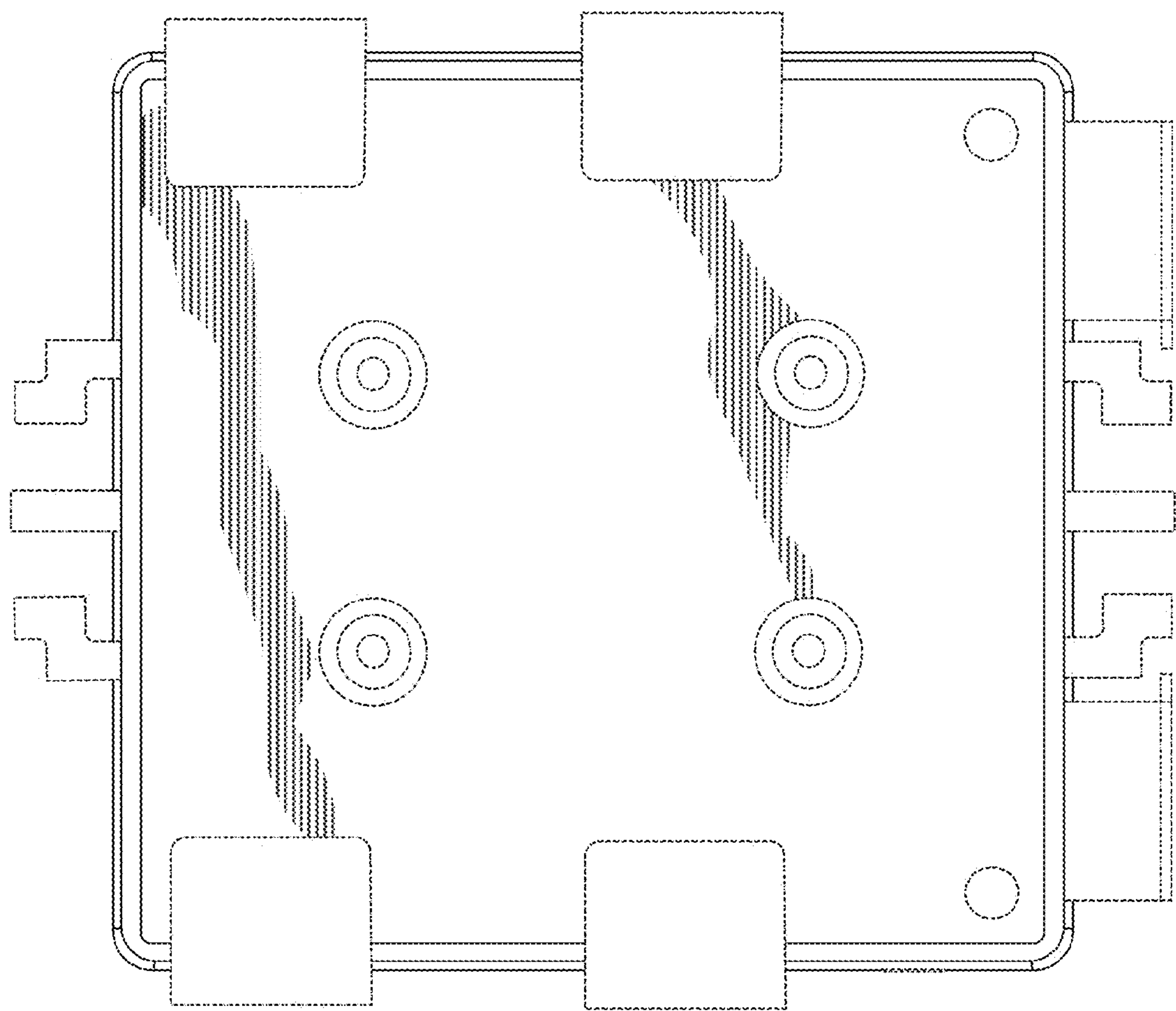


FIG. 20

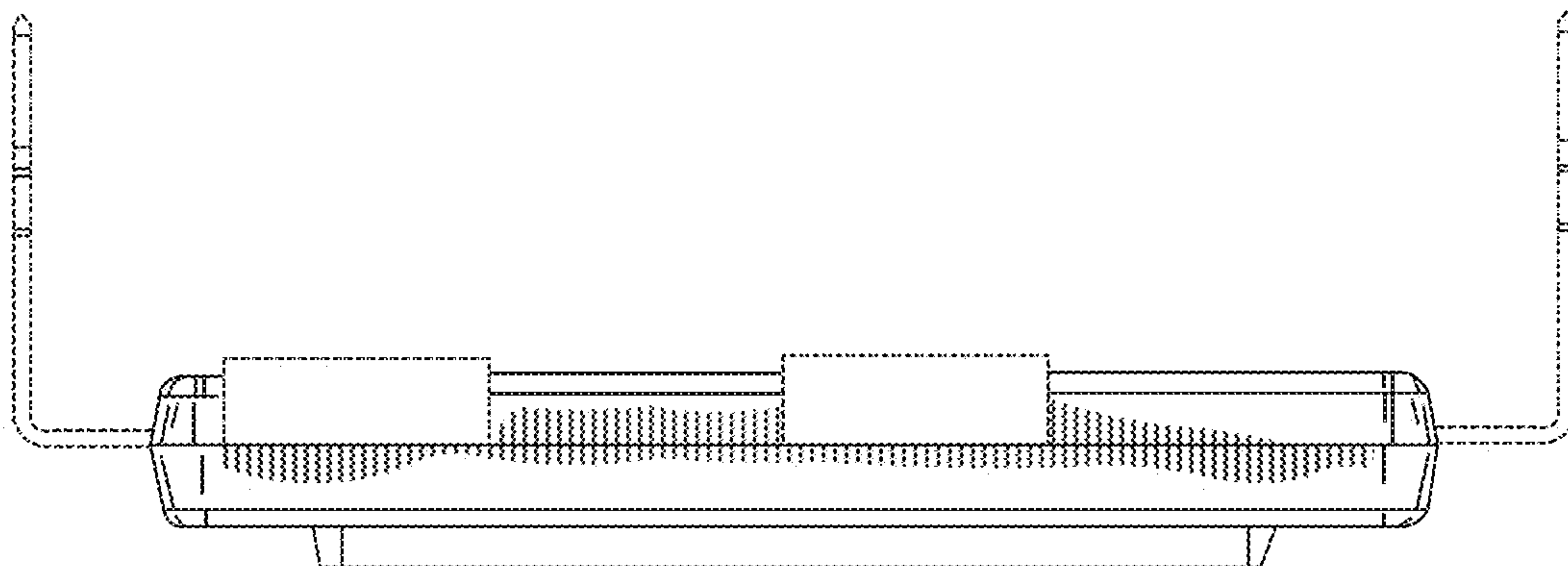


FIG. 21

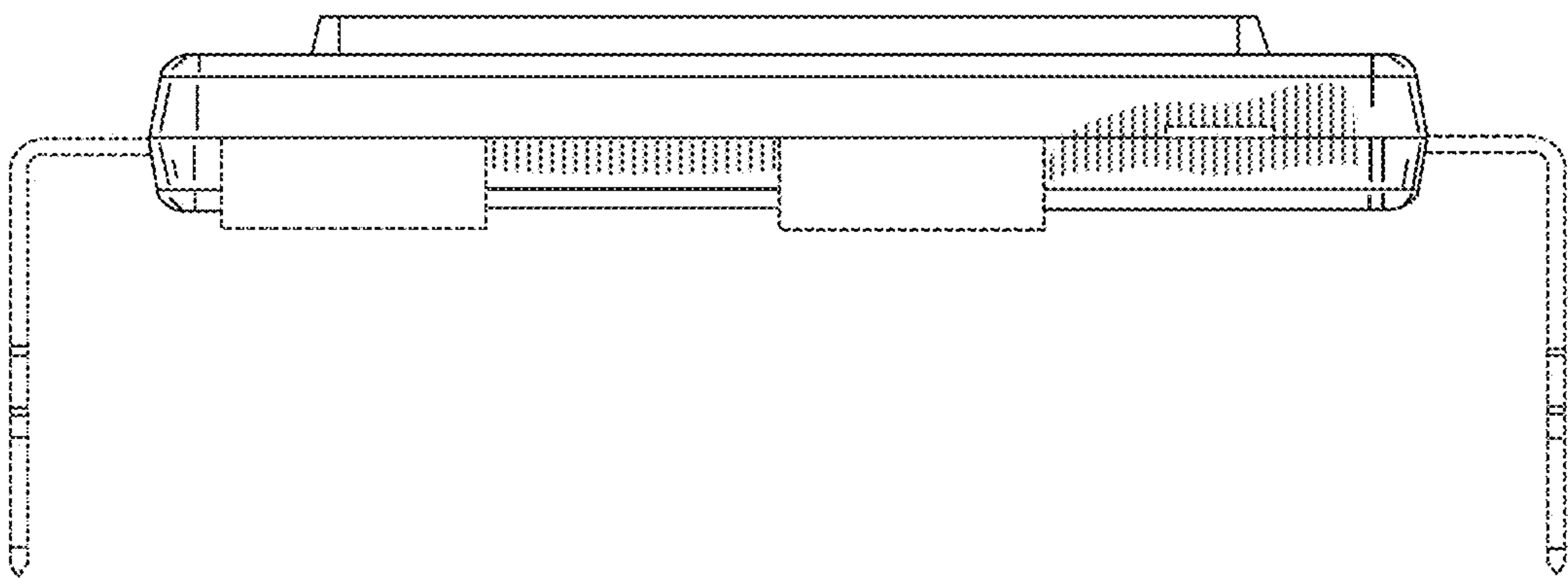


FIG. 22

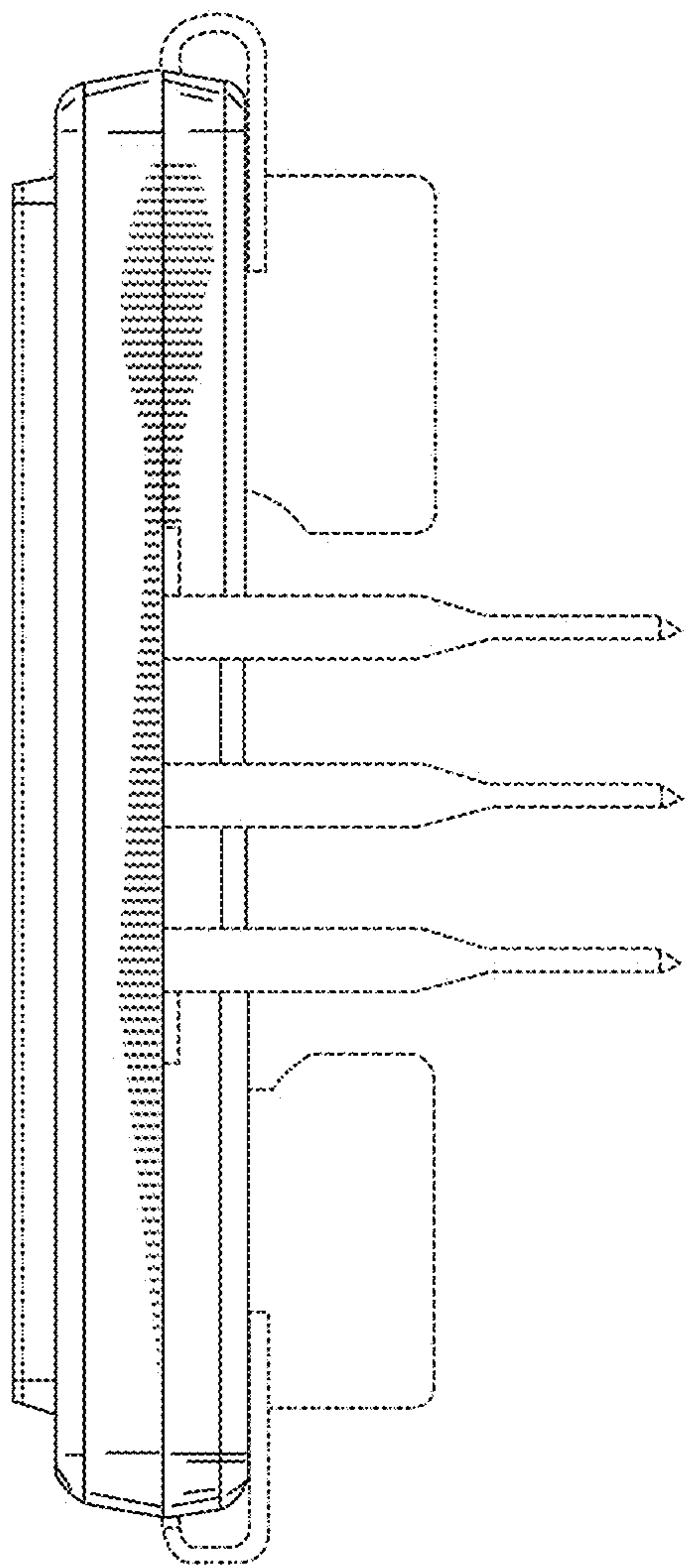


FIG. 23

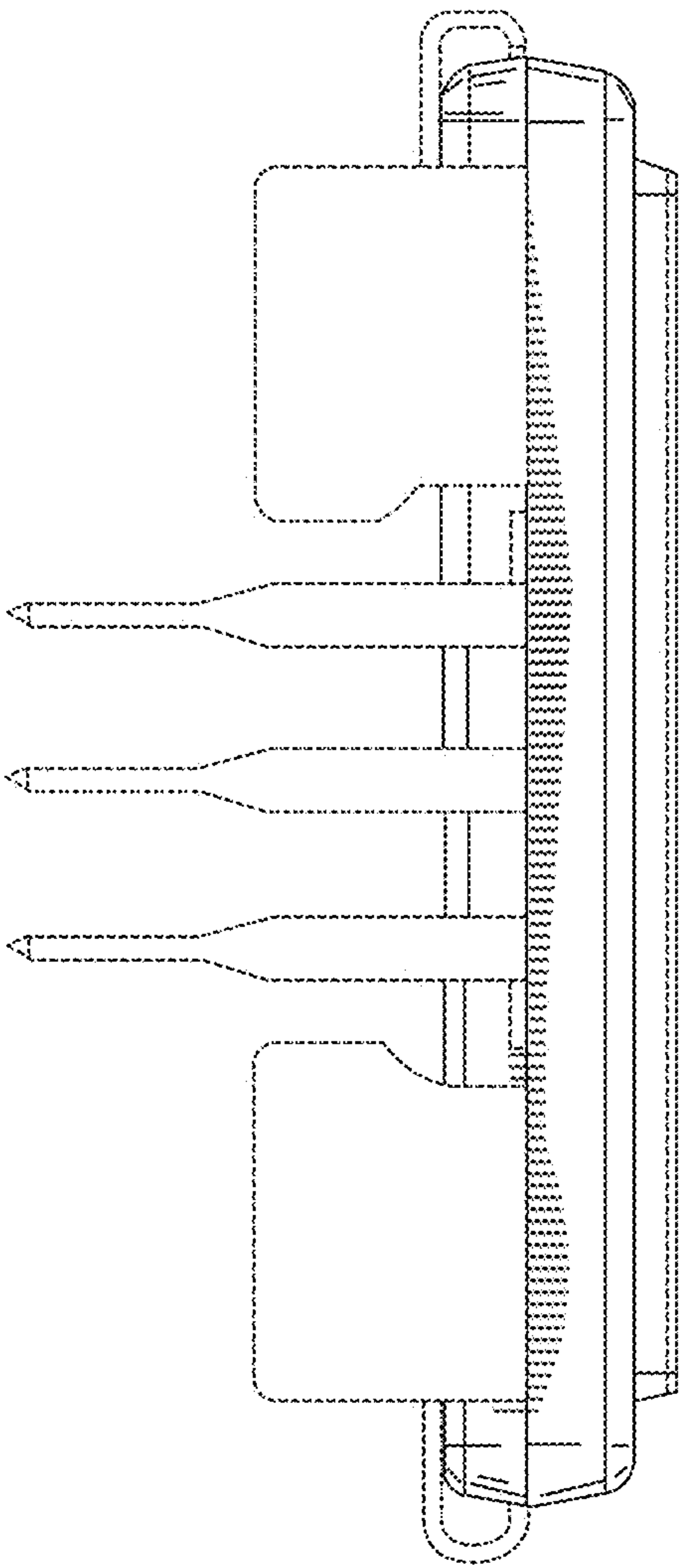


FIG. 24